Preferred Device

General Purpose Transistor

NPN Silicon

These transistors are designed for general purpose amplifier applications. They are housed in the SOT-416/SC-75 package which is designed for low power surface mount applications.

Features

• Pb-Free Package is Available

MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V _{CEO}	40	Vdc
Collector-Base Voltage	V _{CBO}	75	Vdc
Emitter-Base Voltage	V _{EBO}	6.0	Vdc
Collector Current – Continuous	I _C	600	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation (Note 1) $T_A = 25^{\circ}C$	P _D	150	mW
Thermal Resistance, Junction-to-Ambient	$R_{ heta JA}$	833	°C/W
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

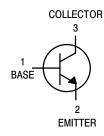
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

 Device mounted on FR4 glass epoxy printed circuit board using the minimum recommended footprint.



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CASE 463 SOT-416/SC-75 STYLE 1

MARKING DIAGRAM



1P = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MMBT2222ATT1	SOT-416	3000 / Tape & Reel
MMBT2222ATT1G	SOT-416 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

FI FCTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Charact	Symbol	Min	Max	Unit		
OFF CHARACTERISTICS		<u> </u>				
Collector – Emitter Breakdown Voltage (Not $(I_C = 1.0 \text{ mAdc}, I_B = 0)$	V _{(BR)CEO}	40	_	Vdc		
Collector – Base Breakdown Voltage ($I_C = 10 \mu Adc, I_E = 0$)	V _{(BR)CBO}	75	-	Vdc		
Emitter – Base Breakdown Voltage ($I_E = 10 \mu Adc$, $I_C = 0$)		V _{(BR)EBO}	6.0	-	Vdc	
Base Cutoff Current (V _{CE} = 60 Vdc, V _{EB} = 3.0 Vdc)	I _{BL}	-	20	nAdc		
Collector Cutoff Current (V _{CE} = 60 Vdc, V _{EB} = 3.0 Vdc)	ICEX	-	10	nAdc		
ON CHARACTERISTICS (Note 2)						
DC Current Gain $ \begin{aligned} &(I_C=0.1 \text{ mAdc, } V_{CE}=10 \text{ Vdc}) \\ &(I_C=1.0 \text{ mAdc, } V_{CE}=10 \text{ Vdc}) \\ &(I_C=10 \text{ mAdc, } V_{CE}=10 \text{ Vdc}) \\ &(I_C=150 \text{ mAdc, } V_{CE}=10 \text{ Vdc}) \\ &(I_C=500 \text{ mAdc, } V_{CE}=10 \text{ Vdc}) \end{aligned} $	H _{FE}	35 50 75 100 40	- - - -	_		
Collector – Emitter Saturation Voltage ($I_C = 150 \text{ mAdc}$, $I_B = 15 \text{ mAdc}$) ($I_C = 500 \text{ mAdc}$, $I_B = 50 \text{ mAdc}$)		V _{CE(sat)}	- -	0.3 1.0	Vdc	
Base – Emitter Saturation Voltage ($I_C = 150 \text{ mAdc}$, $I_B = 15 \text{ mAdc}$) ($I_C = 500 \text{ mAdc}$, $I_B = 50 \text{ mAdc}$)	V _{BE(sat)}	0.6	1.2 2.0	Vdc		
SMALL-SIGNAL CHARACTERISTICS						
Current-Gain - Bandwidth Product (I _C = 20 mAdc, V _{CE} = 20 Vdc, f = 100 MI	Hz)	f⊤	300	_	MHz	
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 1.0 MHz)		C _{obo}	-	8.0	pF	
Input Capacitance ($V_{EB} = 0.5 \text{ Vdc}$, $I_{C} = 0$, $f = 1.0 \text{ MHz}$)		C _{ibo}	-	30	pF	
Input Impedance ($V_{CE} = 10 \text{ Vdc}$, $I_{C} = 10 \text{ mAdc}$, $f = 1.0 \text{ kHz}$	z)	h _{ie}	0.25	1.25	kΩ	
Voltage Feedback Ratio $(V_{CE} = 10 \text{ Vdc}, I_C = 10 \text{ mAdc}, f = 1.0 \text{ kHz})$	h _{re}	-	4.0	X 10 ⁻⁴		
Small – Signal Current Gain ($V_{CE} = 10 \text{ Vdc}, I_{C} = 10 \text{ mAdc}, f = 1.0 \text{ kHz}$	z)	h _{fe}	75	375	_	
Output Admittance (V _{CE} = 10 Vdc, I _C = 10 mAdc, f = 1.0 kH.	h _{oe}	25	200	μmhos		
Noise Figure (V_{CE} = 10 Vdc, I_{C} = 100 μ Adc, R_{S} = 1.0	NF	-	4.0	dB		
SWITCHING CHARACTERISTICS		-				
Delay Time	$(V_{CC} = 3.0 \text{ Vdc}, V_{BE} = -0.5 \text{ Vdc},$	t _d	_	10		
Rise Time	$I_C = 150 \text{ mAdc}, I_{B1} = 15 \text{ mAdc})$	t _r		25	ns	
Storage Time $(V_{CC} = 30 \text{ Vdc}, I_C = 150 \text{ mAdc},$ Fall Time $I_{B1} = I_{B2} = 15 \text{ mAdc})$		t _s	-	225 60	- ns	
i dii fillio	J. JL ,	- OO				

Device mounted on FR4 glass epoxy printed circuit board using the minimum recommended footprint.
 Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2.0%.

SWITCHING TIME EQUIVALENT TEST CIRCUITS

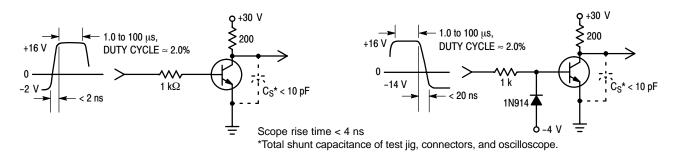


Figure 1. Turn-On Time

Figure 2. Turn-Off Time

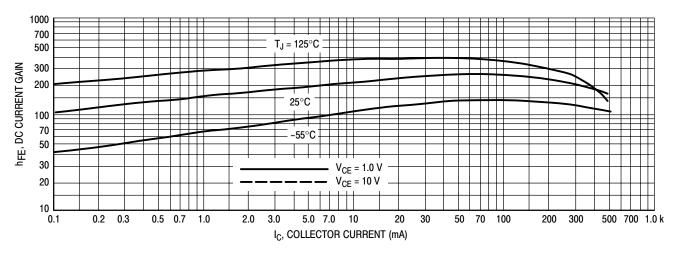


Figure 3. DC Current Gain

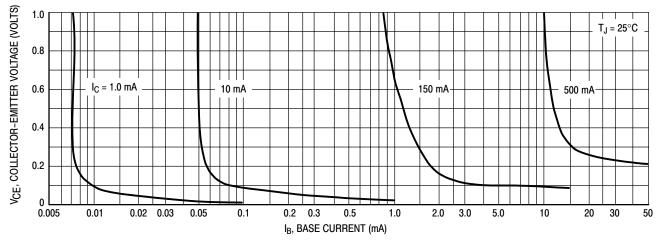


Figure 4. Collector Saturation Region

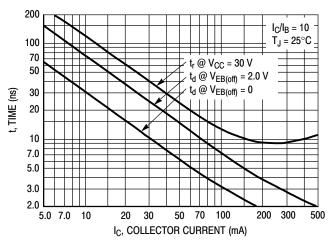


Figure 5. Turn-On Time

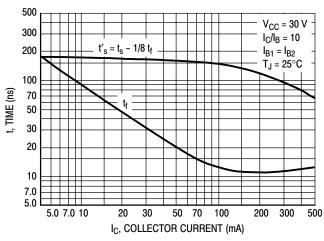


Figure 6. Turn-Off Time

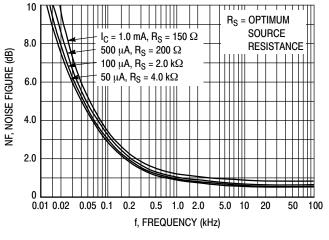


Figure 7. Frequency Effects

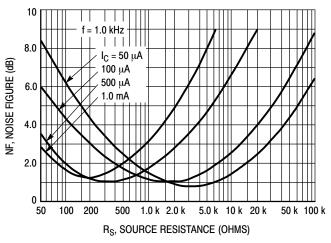


Figure 8. Source Resistance Effects

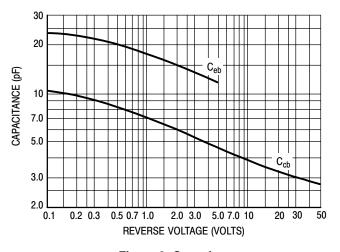


Figure 9. Capacitances

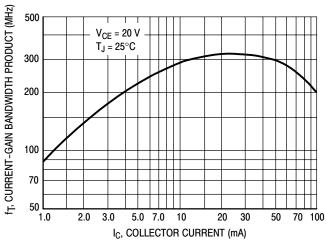


Figure 10. Current-Gain Bandwidth Product

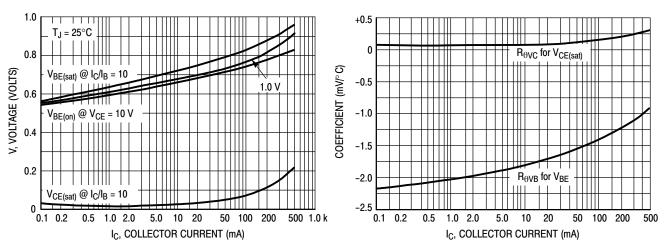
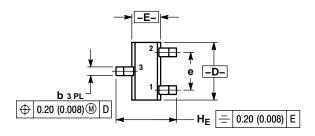


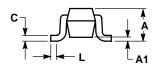
Figure 11. "On" Voltages

Figure 12. Temperature Coefficients

PACKAGE DIMENSIONS

SC-75/SOT-416 CASE 463-01 ISSUE F





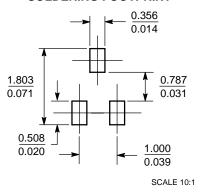
- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.70	0.80	0.90	0.027	0.031	0.035
A1	0.00	0.05	0.10	0.000	0.002	0.004
b	0.15	0.20	0.30	0.006	0.008	0.012
С	0.10	0.15	0.25	0.004	0.006	0.010
D	1.55	1.60	1.65	0.059	0.063	0.067
E	0.70	0.80	0.90	0.027	0.031	0.035
е	1.00 BSC			0	.04 BS0	
L	0.10	0.15	0.20	0.004	0.006	0.008
HE	1.50	1.60	1.70	0.061	0.063	0.065

STYLE 1: PIN 1. BASE 2. EMITTER 3. COLLECTOR

(mm inches

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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